REMARKS

The Examiner is thanked for the performance of a thorough search. In response to the

Office Action mailed February 15, 2002, claims 21, 22, and 23 have been added, claims 1, 8 and

18 have been amended, and claims 2 and 9 have been canceled. All issues raised in the Office

Action are addressed herein. No new matter has been added. Claims 1, 3-8, and 10-23 are

currently pending in this Application. Applicants respectfully request the reconsideration of the

application.

Rejections Under 35 U.S.C. 103(a)

Claims 1-4, 6, 8-11, 13, and 15-20 are rejected under 35 U.S.C. 103(a) as being

unpatentable over Ryum et al., hereinafter Ryum (US Patent No. 6,337,494) in view of Kubota

(US Patent No. 6,323,530).

Claims 5, 7, 12, and 14 are rejected under 35 U.S.C. 103(a) as being unpatentable over

Ryum in view of Kubota, as applied in claim 1 above, and further in view of Streetman (Solid

State Electronic Devices).

Cited Art

Ryum discloses a super self-aligned heterojunction bipolar transistor which is capable of

miniaturizing an element, simplifying the process step thereof without using a trench isolation

process and sophisticated epitaxial growth processes.

Kubota discloses an optical diode device including a dummy mesa stripe formed on the

semiconductor substrate, having a wider top surface as compared to the conventional optical

semiconductor, allowing for an upper electrode with relatively wide area and an improved

connection between the device and the mount base in a face-down mounting.

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combination of <u>Ryum</u> with <u>Kubota</u> would not produce the bipolar transistor of the present invention.

Claims 3-7, 10-17, and 19-20 directly or indirectly depend from and contain all the patentably distinguishing limitations of allowable independent claims 1, 8 and 18 respectively. Therefore, Applicants respectfully submit that dependent claims 3-7, 10-17, and 19-20 are patentable for at least the same reasons as the independent claims from which they depend, and respectfully request the Examiner to withdraw the rejection.

Ciaims 2, and 9 were canceled and the claimed elements were incorporated into claims 1, 8 and 18.

Conclusion

For the forgoing reasons, Applicants submit that all pending claims are allowable and respectfully requests a Notice of Allowance for this application from the Examiner. Should the Examiner believe that a telephone conference would expedite the prosecution of this application, the undersigned can be reached at the telephone number set out below.

Respectfully submitted,

Rambod Mader

Reg. No: 47, 262

DATE: April 25, 2002

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CERTIFICATE OF MAILING (37 CFR 1.8(a))	
I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited on April 25, 2002, with the U.S. Postal Service as first class mail in an envelope addressed to: Commissioner of Patents, Washington, D.C., 20231.	
Postal Service as first class mail in an envelope addressed to. Commissioner of Fa	ichs, Wahington, B.C., 20251.
Date:April 25, 2002	Vicki Naso

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Marked up version of the claims

In the claims

Please amend the claims as follows:

1. (Amended) A method for forming a super self-aligned bipolar transistor, comprising the steps of:

providing a semiconductor substrate having a buried collector region;

providing multiple layers above said collector region;

providing an emitter window mask above said multiple layers;

providing three vertical etchings of said multiple layers;

providing a doping of said collector region wherein the doped collector region is determined by the emitter window mask;

providing a horizontal etching of one of said multiple layers, wherein the step of providing a horizontal etching determines that the dimensions of the base region are

wider than the dimensions of the doped collector region and the emitter region;

providing a wet etching to remove a final one of said multiple layers; and

providing a base region above said collector region in the horizontally etched area;

providing an emitter region above the base region so that the emitter, base and collector

regions are super self-aligned.

8. (Amended) A super self-aligned bipolar transistor apparatus, comprising:

a semiconductor substrate having a buried collector region;

multiple layers above said collector region;

an emitter window mask above said multiple layers;

a doped collector region wherein the width of the doped collector region are equal to the

emitter window mask width;

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a horizontally etched region of one of said multiple layers, wherein the dimensions of the horizontally etched region determine that the dimensions of the base region are wider than the

doped collector region and the emitter region of the transistor;

a base region above said collector region in the horizontally etched region;

an emitter region above the base region so that the emitter, base and collector regions are

super self-aligned.

18. (Amended) A method for forming a super self-aligned bipolar transistor, comprising the

steps of:

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providing a silicon semiconductor substrate having a buried collector region;

providing a first oxide layer, a polysilicon layer, and a second oxide layer above said

collector region;

providing a Nitride emitter window mask above said oxide and polysilicon layers;

providing a wet etching with hydrofluoric acid solutions to etch said first and second

oxide layers;

providing a horizontal plasma etching of said polysilicon layer, wherein the dimensions

of the horizontally etched region determine that the dimensions of the base region are wider than

the doped collector region and the emitter region of the transistor;

providing a doping of said collector region wherein the doped collector region is

determined by the emitter window mask;

providing a base region above said collector region in the horizontally etched area;

wherein the base region extends horizontally beyond the doped collector region;

providing an emitter region above the base region so that the emitter, base and collector

regions are super self-aligned.

21. (New) A method for forming a super self-aligned bipolar transistor, comprising the steps

of:

providing a semiconductor substrate having a buried collector region;

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providing multiple layers above said collector region;

providing an emitter window mask above said multiple layers;

providing three vertical etchings of said multiple layers;

providing a doping of said collector region wherein the doped collector region is

determined by the emitter window mask;

providing a horizontal etching of one of said multiple layers, wherein the step of

providing a horizontal etching determines that the dimensions of the base region are

wider than the dimensions of the doped collector region and the emitter region;

providing a wet etching to remove a final one of said multiple layers; and

providing a base region above said collector region in the horizontally etched area;

providing an emitter region above the base region so that the emitter, base and collector

regions are super self-aligned.

22. (New) The method of claim 21 wherein the horizontal etching is performed to a distance

greater than the polysilicon layer thickness, and whereby the distance may be conformed to

provide desired electrical characteristics.

23. (New) The method of claim 22 wherein the desired electrical characteristics are transistor

gain and frequency response.

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